

SAMSUNG

# **LED Module**

## **Revision History**

Rev.No	Data	Page	Revision	Remark
1.0	luby 2012		The first preliminary specification is	
1.0	July, 2013	-	established. Total 13 pages	-
			Merged two types, square/rectangular	
1.5	January 2014	-	Updated specification.	-
			Total 12 pages	
2.0	March 2014		Release specification	
2.0		-	Total 12 pages	-
		4	The information of ESD has been added.	-
			The Fundamental specification has been	
2.1	March 2014	4	added. (Type Classification, Eye Protection,	-
2.1			Working Voltage for Insulation)	
		6, 7	The Appearance drawing has been changed.	-
		10	Added certification.	-
2.5	May 2014	1,5	Higher flux version is added in the product list	
2.5		1,5	Total 12 pages	-
			Min and Max values of higher flux version is	
3.0	June 2014	4	added.	
5.0	June 2014	-	RT drawing is updated since hole size	-
			increase to 4.7mm.	

## Contents

1	Products and Applications	3
2	Specification	3
3	Structure and Assembly	5
4	Approbation	9
5	Packing	10
6	Precautions In Handling	10



## 1. Products and Application

This specification defines general specification and performance for Lens Attached LED module. Samsung LAM products target to replace conventional fluorescent lamps as T5, T8 and so on with LED solutions. Due to transferring LED, new luminaire transferred to LED can take more energy saving and longer life-time.

In special, Samsung has competitiveness in middle-power solutions. This module uses LM561B. Middle power solutions provide more homogeneous and higher efficient lights.

## 2. Specification

No.	Item	Specifications	Unit	Remark
1	Dimension	SQ : 259(L) x 250(W) x 5.8(h) RT : 216(L) x 273(W) x 7.4(h)	mm	Tolerance:±0.5mm
2	Weight	SQ : 93, RT : 85	g	Tolerance:±10%
3	Rated lifetime	>50,000	hour	L70B50 @Tc = 75℃
4	Ingress Protection	N/A	-	-
5	Operating Temperature	Ta = - 20 ~ 50	Ĉ	-
6	Storage Temperatue	Ta = - 40 ~ 80	Ĉ	-
7	ESD	8	KV	-
8	Type Classification	Built-in module		
9	Eye Protection	· Risk group 1		
10	Working Voltage for Insulation	· 25 [V]		

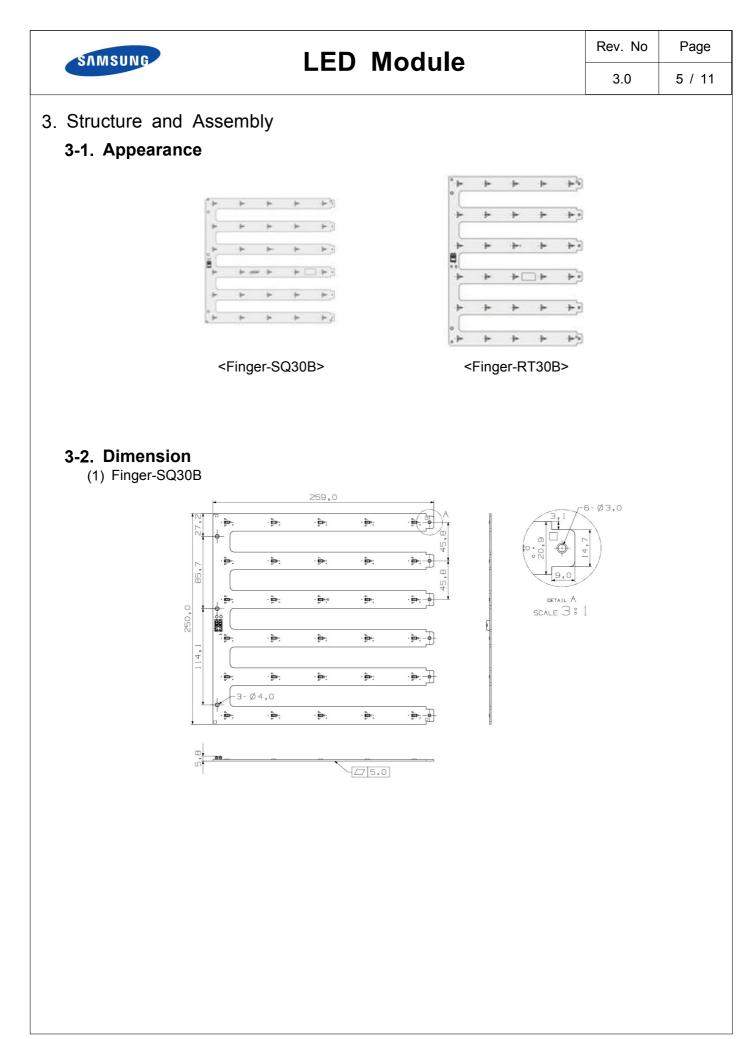
SAMSUNG

## **LED Module**

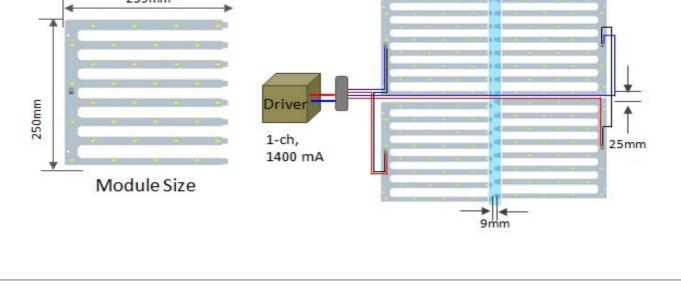
	ll a se			Specificat	ions			Descrit	
No.	Item	Sym. Model Min. Nom. Max.		Max.	Unit	Remark			
			3000K	1288	1420	1565			
			3500K	1309	1450	1591		@700mA	
16	Luminous flux	Φν	4000K	1351	1500	1642	Im	@700mA,	
			5000K	1393	1540	1693		Tp = 35℃	
			6500K	1354	1490	1645			
			3000K	_	133	_			
			3500K	_	136	_		@700mA	
17	Efficiency	LPW	4000K	-	140	-	lm/W		
			5000K	-	144	-	]	Tp = 35℃	
			6500K	-	139	-			
18	Operating Current	lop	-	-	700	900	mA	-	
19	Operating Voltage	Vdc	_	13.8	15.3	16.8	V	@700mA,	
19		vuc	-	13.0	13.5	10.0	V	Tp = 35℃	
20	Power Consumption	_	_	_	10.7	_	W	@700mA,	
20					10.7		~~	Tp = 35℃	

No.	Item			Specificati		Unit	Remark		
NO.	liem	Sym.	Model	Min.	Nom.	Max.	Onit	Remark	
0.1	0DOM		~4000K	-	3	-		LED to LED,	
21	SDCM	-	5000K~	-	4	-	step	MacAdam @ initial time	
22	Color Rendering Index	CRI	-	80	-	-	Ra	-	
			3000K	2852	2970	3094			
			3500K	3189	3337	3493			
23	ССТ	-	4000K	3762	3958	4181	к	@700mA Tp = 35℃	
			5000K	4709	5016	5369			
			6500K	6130	6563	7083			

\* Measurement tolerance of luminous flux becomes  $\pm$  7% in the value, measurement tolerance of Vf becomes  $\pm$  0.3V in the value and the measurement tolerance of the color coordinates is  $\pm$  0.005.



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(2) Fi	nger-RT30B					
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	Item	Specifications		Item	Specificatio	ns
L	1			Item Length of PCB	Specificatio 259.0 ± 0.5	
L W	Item	Specifications	L			mn
	Item Length of PCB	Specifications 216.0 ± 0.5 mm		Length of PCB	259.0 ± 0.5	mn mn
W	Item Length of PCB Width of PCB	Specifications   216.0 ± 0.5 mm   273.0 ± 0.5 mm	W	Length of PCB Width of PCB	259.0 ± 0.5 250.0 ± 0.5	i mm i mm mm
W H1	Item Length of PCB Width of PCB Thickness of PCB	Specifications   216.0 ± 0.5 mm   273.0 ± 0.5 mm   1.6 ± 0.1 mm	W H1	Length of PCB Width of PCB Thickness of PCB	259.0 ± 0.5 250.0 ± 0.5 1.6 ± 0.1	i mm i mm mm
W H1 H2	Item Length of PCB Width of PCB Thickness of PCB	Specifications   216.0 ± 0.5 mm   273.0 ± 0.5 mm   1.6 ± 0.1 mm	W H1	Length of PCB Width of PCB Thickness of PCB	259.0 ± 0.5 250.0 ± 0.5 1.6 ± 0.1	i mm i mm mm
W H1 H2 3. As	Item Length of PCB Width of PCB Thickness of PCB Height of PCBA	Specifications   216.0 ± 0.5 mm   273.0 ± 0.5 mm   1.6 ± 0.1 mm	W H1 H2	Length of PCB Width of PCB Thickness of PCB Height of PCBA	259.0 ± 0.5 250.0 ± 0.5 1.6 ± 0.1	i mm i mm mm





# **LED Module**

#### (2) Design case of 1x4 (300mm x 1200mm) luminaire, 4 set of LAM-RT30B

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### (3) Fixation by Hook



## 3-4. Structure

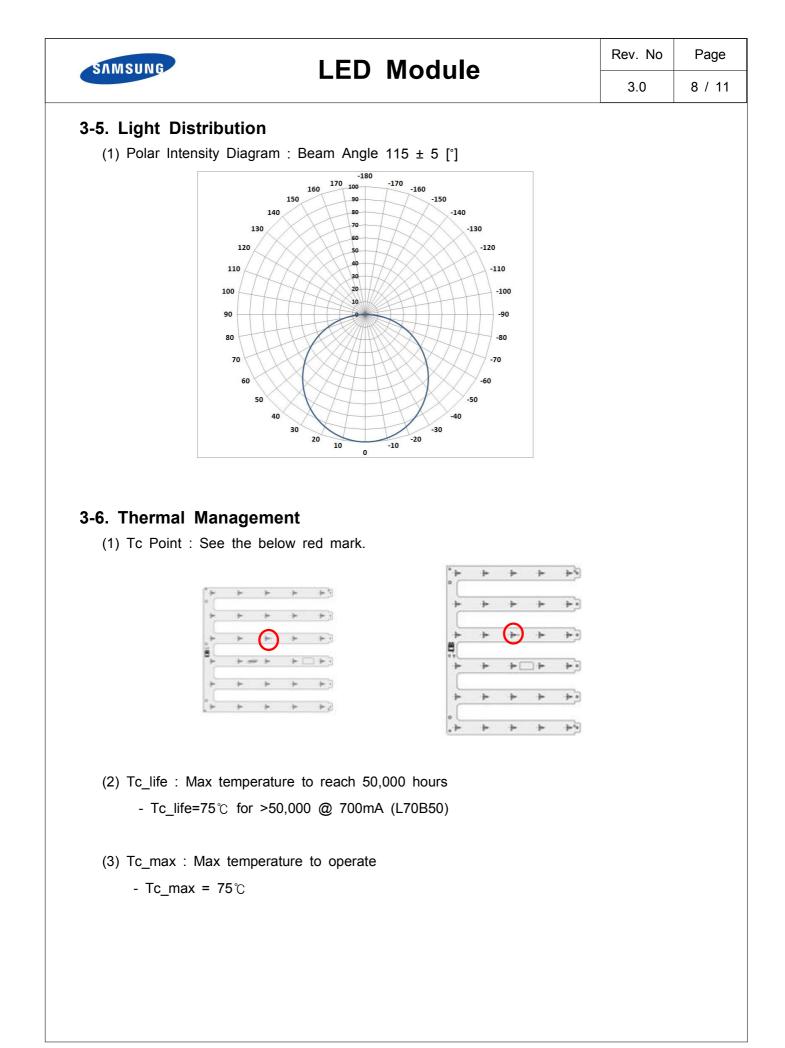
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#### <Finger-SQ30B>

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4.1	+	+	4	•
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<Finger-RT30B>

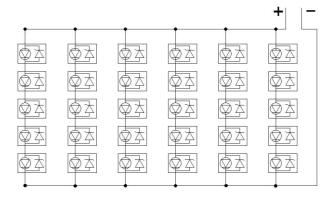
	•						
No.		Item	Specifications				
	3-1	LED	LM561B : Middle Power LED 30 ea				
Module Assembly	3-2	PCB	Material : Copper, Solder mask and Epoxy				
, 100011101y	3-3	Connector	AWG 24-18, Strip Length 6-7 mm				





# **LED Module**

## 3-7. Circuit Schematic



## 4. Approbation

Item	Compliant to	Result / Remark		
General	Eye safety : IEC62471	LM561B LED		
Hazardous Substance & Materials	RoHS, Reach	Declared		
	CE	EN 62031:2008/A1:2013 EN 62471:2008		
Certification	ENEC	EN 62031:2008/A1:2013 EN 62471:2008		

## 5. Packing

## 5-1 Dimension & Module Q'ty

#### (1) Finger-SQ30B

Item	1 box	1 pallet			
Dimension	365 x 332 x 295 mm	1100 x 800 x 145 mm			
Q'ty	60 modules	1800 modules, 30 boxes			

#### (2) Finger-RT30B

Item	1 box	1 pallet
Dimension	375 x 280 x 295 mm	1200 x 800 x 145 mm
Q'ty	60 modules	2400 modules, 40 boxes



## 6. Precautions In Handling

1) LED Lighting for white light are devices which are materialized by combining white LEDs. The color of white light can differ a little unusually to diffuser plate(sign-board panel).

#### 2) Handling

- Don't drop the unit and don't give the unit any shocks.
- Don't storage the Module in a dusty place or room.
- Don't take the unit to pieces.

#### 3) Cleaning

- This LED Module should not be used in any type of fluid such as oil, organic solvent, etc.
- It is recommended that IPA(Isopropyl Alcohol) be used as a solvent for cleaning the LED Module.
- When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations. Do not clean the LED Module by the ultrasonic.
- Before cleaning, a pre-test should be done to confirm whether any damage to the LED Lighting will occur.

#### 4) Static Electricity

- Static electricity or surge voltage damages the LED Lighting.
- 5) Discoloration
  - VOCs (volatile organic compounds) may be occurred by adhesives, flux, hardener or organic additives which is used in luminaires (fixture) and LED silicone bags are permeable to it. It may lead a discoloration when LED expose to heat or light.
  - This phenomenon can give a significant loss of light emitted(output) from the luminaires(fixtures).
  - In order to prevent these problems, we recommend you to know the physical properties for the materials used in luminaires, it requires to select carefully.

#### 6) Risk of Sulfurization (or Tarnishing)

- The lead frame from Samsung Electronics is a plated package and it may change to black (or dark colored) when it is exposed to Ag (a), Sulfur (S), Cchlorine (Cl) or other halogen compound. It requires attention.
- Sulfide (Sulfurization) of the lead frame may cause a change of degradation intensity, chromaticity coordinates and it may cause open circuit in extreme cases. It requires attention.
- Sulfide (Sulfurization) of the lead frame may cause of storage and using with oxidizing substances together. Therefore, LED is not recommend to use and store with the below list.
  - : Rubber, Plain paper, lead solder cream etc.



#### 7) Others

- If over voltage which exceeds the absolute maximum rating is applied to LED Lighting,
- it will cause damage Circuits(that LED is included) and result in destruction.
- Do not directly look into lighted LED with naked eyes for long time.

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